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Kind regards,

Team Nexperia

PESD5V0L1UA; PESD5V0L1UB; PESD5V0L1UL

Low capacitance unidirectional ESD protection diodes

Rev. 01 — 17 June 2009

Product data sheet

1. Product profile

1.1 General description

Low capacitance unidirectional ElectroStatic Discharge (ESD) protection diodes in small Surface-Mounted Device (SMD) plastic packages designed to protect one signal line from the damage caused by ESD and other transients.

Table 1.Product overview

Type number	Package		Package configuration
	NXP	JEITA	
PESD5V0L1UA	SOD323	SC-76	very small
PESD5V0L1UB	SOD523	SC-79	ultra small and flat lead
PESD5V0L1UL	SOD882	-	leadless ultra small

ESD protection up to 26 kV

IEC 61000-4-2; level 4 (ESD)

Subscriber Identity Module (SIM) card

AEC-Q101 qualified

protection

FireWire

Portable electronics

High-speed data lines

1.2 Features

- Unidirectional ESD protection of one line
- Low diode capacitance: C_d = 25 pF
- Low clamping voltage: V_{CL} = 12 V
- Very low leakage current: I_{RM} = 10 nA

1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Communication systems

1.4 Quick reference data

Table 2.Quick reference data

 $T_{amb} = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{RWM}	reverse standoff voltage		-	-	5.0	V
C _d	diode capacitance	$f = 1 \text{ MHz}; V_R = 0 \text{ V}$	-	25	30	pF



Low capacitance unidirectional ESD protection diodes

2. Pinning information

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
PESD5V0	DL1UA; PESD5V0L1UB		
1	cathode	[1]	
2	anode	1 2 001aab540	1 2 006aaa152
PESD5V)L1UL		
1	cathode	[1]	
2	anode	1 2 Transparent top view	1 2 006aaa152

[1] The marking bar indicates the cathode.

3. Ordering information

Table 4. Order	ing informati	ion	
Type number	Package		
	Name	Description	Version
PESD5V0L1UA	SC-76	plastic surface-mounted package; 2 leads	SOD323
PESD5V0L1UB	SC-79	plastic surface-mounted package; 2 leads	SOD523
PESD5V0L1UL	-	leadless ultra small plastic package; 2 terminals; body $1.0 \times 0.6 \times 0.5$ mm	SOD882

4. Marking

Table 5. Marking codes

3 • • • • • • • • • • • • • • • • • • •	
Type number	Marking code
PESD5V0L1UA	1J
PESD5V0L1UB	Z8
PESD5V0L1UL	XY

Low capacitance unidirectional ESD protection diodes

5. Limiting values

Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{PP}	peak pulse power	$t_p = 8/20 \ \mu s$	<u>[1][2]</u>	42	W
I _{PP}	peak pulse current	$t_p = 8/20 \ \mu s$	<u>[1][2]</u>	3.5	А
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

[2] Measured from pin 1 to pin 2.

Table 7.ESD maximum ratings

 $T_{amb} = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Max	Unit
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[1]</u>	-	26	kV
		machine model		-	400	V
		MIL-STD-883 (human body model)		-	10	kV

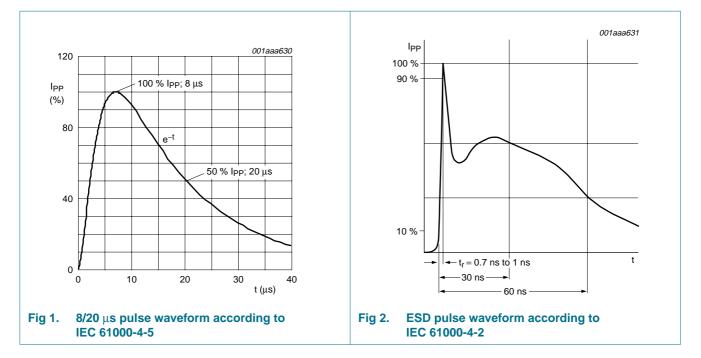
[1] Device stressed with ten non-repetitive ESD pulses.

Table 8. ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3 (human body model)	> 4 kV

PESD5V0L1UA/UB/UL

Low capacitance unidirectional ESD protection diodes



6. Characteristics

Table 9.Characteristics

 $T_{amb} = 25 \circ C$ unless otherwise specified.

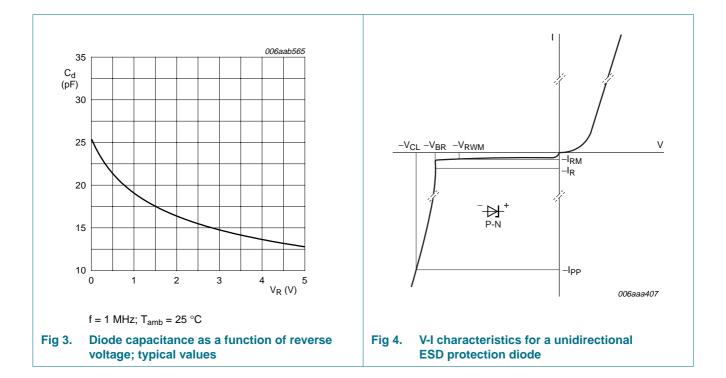
' amb - 20	e unicos ourier moe speen	icu.				
Symbol	Parameter	Conditions	Mir	п Тур	Max	Unit
V _{RWM}	reverse standoff voltage		-	-	5.0	V
I _{RM}	reverse leakage current	$V_{RWM} = 5.0 V$	-	10	100	nA
V _{BR}	breakdown voltage	I _R = 5 mA	6.4	6.8	7.2	V
C _d	diode capacitance	f = 1 MHz; V _R = 0 V	-	25	30	pF
V _{CL}	clamping voltage		[1][2]			
		I _{PP} = 1 A	-	-	9	V
		I _{PP} = 3.5 A	-	-	12	V
r _{dif}	differential resistance	I _R = 5 mA	-	-	30	Ω
V _F	forward voltage	I _F = 200 mA	-	-	1.2	V

[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

[2] Measured from pin 1 to pin 2.

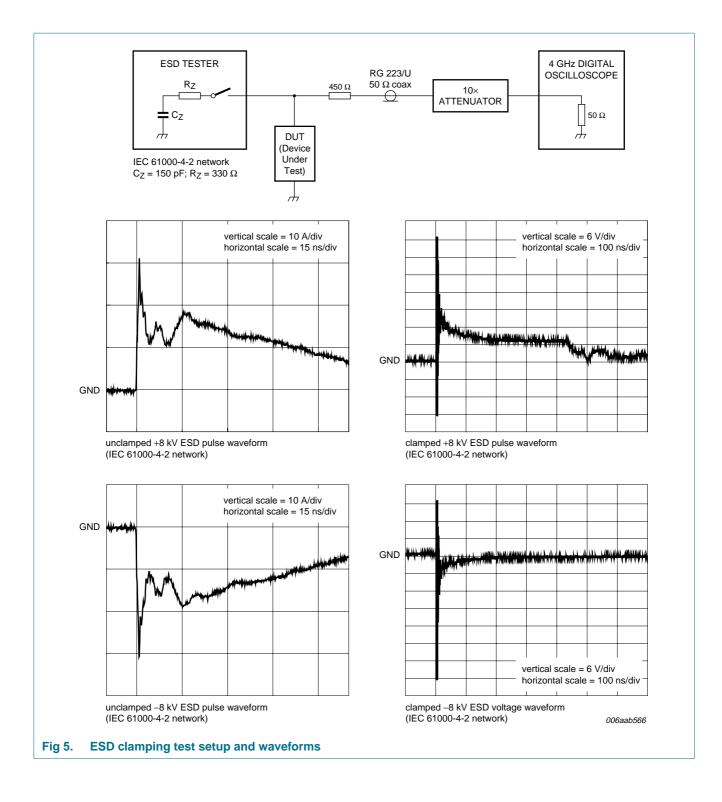
PESD5V0L1UA/UB/UL

Low capacitance unidirectional ESD protection diodes



PESD5V0L1UA/UB/UL

Low capacitance unidirectional ESD protection diodes

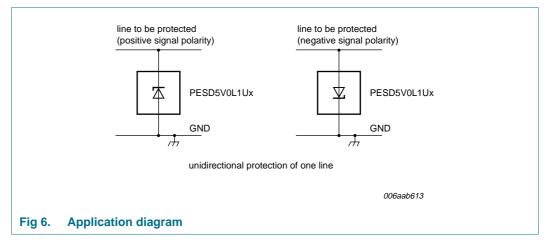


PESD5V0L1UA_UB_UL_1

Low capacitance unidirectional ESD protection diodes

7. Application information

The PESD5V0L1Ux series is designed for the protection of one unidirectional data or signal line from the damage caused by ESD and surge pulses. The devices may be used on lines where the signal polarities are either positive or negative with respect to ground. The PESD5V0L1Ux series provides a surge capability up to 42 W per line for an 8/20 μ s waveform.



Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD and Electrical Fast Transient (EFT). The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. The path length between the device and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

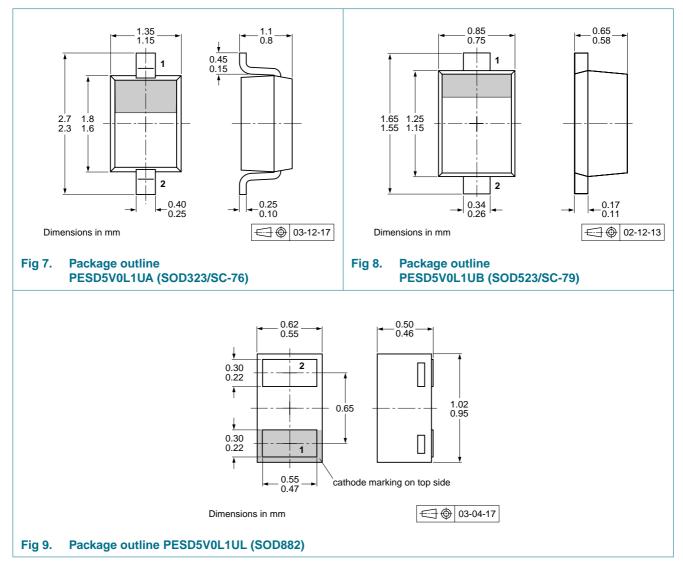
8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

Low capacitance unidirectional ESD protection diodes

9. Package outline



10. Packing information

Table 10. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

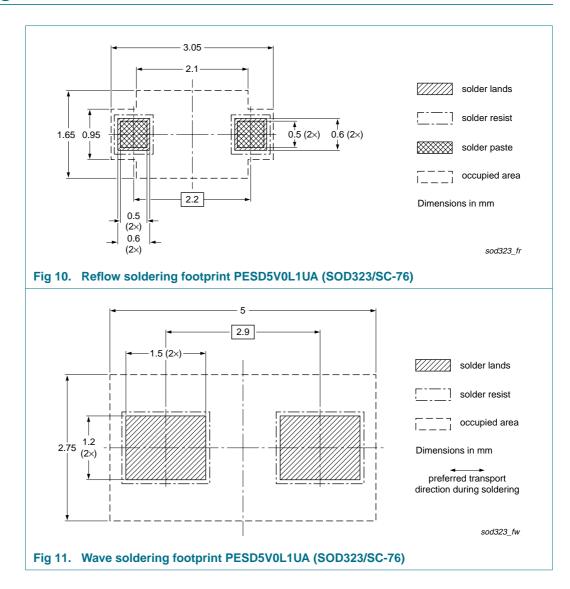
Package	Description	Packing quantity		
		3000	8000	10000
SOD323	4 mm pitch, 8 mm tape and reel	-115	-	-135
SOD523	2 mm pitch, 8 mm tape and reel	-	-315	-
	4 mm pitch, 8 mm tape and reel	-115	-	-135
SOD882	2 mm pitch, 8 mm tape and reel	-	-	-315
	SOD323 SOD523	SOD323 4 mm pitch, 8 mm tape and reel SOD523 2 mm pitch, 8 mm tape and reel 4 mm pitch, 8 mm tape and reel	3000 SOD323 4 mm pitch, 8 mm tape and reel -115 SOD523 2 mm pitch, 8 mm tape and reel - 4 mm pitch, 8 mm tape and reel - 115 -	SOD323 4 mm pitch, 8 mm tape and reel -115 - SOD523 2 mm pitch, 8 mm tape and reel - -315 4 mm pitch, 8 mm tape and reel - - -

[1] For further information and the availability of packing methods, see Section 14.

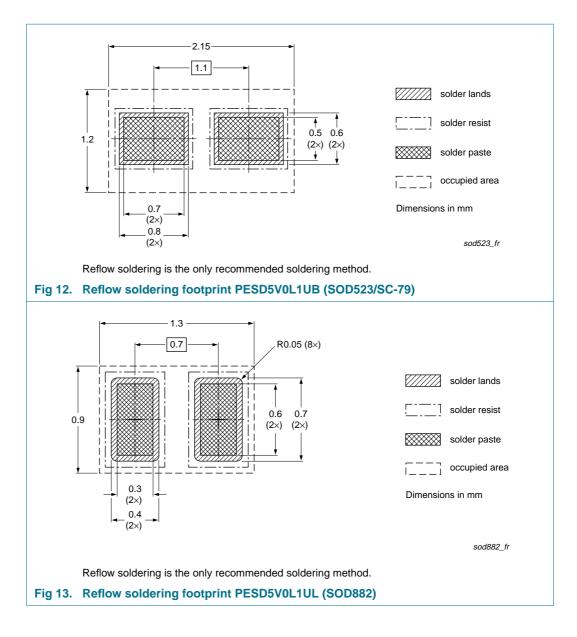
PESD5V0L1UA_UB_UL_1
Product data sheet

Low capacitance unidirectional ESD protection diodes

11. Soldering



Low capacitance unidirectional ESD protection diodes



PESD5V0L1UA_UB_UL_1

Low capacitance unidirectional ESD protection diodes

12. Revision history

Table 11. Revision history	у			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PESD5V0L1UA_UB_UL_1	20090617	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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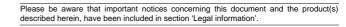
Product data sheet

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Low capacitance unidirectional ESD protection diodes

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